

INTERCONNECTS

SERIES 830, 831, 832, 833 • 2mm GRID HEADERS AND SOCKETS • SINGLE AND DOUBLE ROW STRIPS

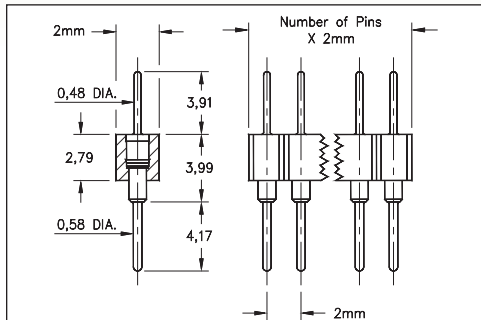


FIG. 1

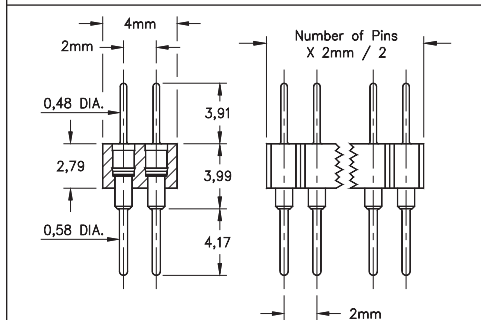


FIG. 2

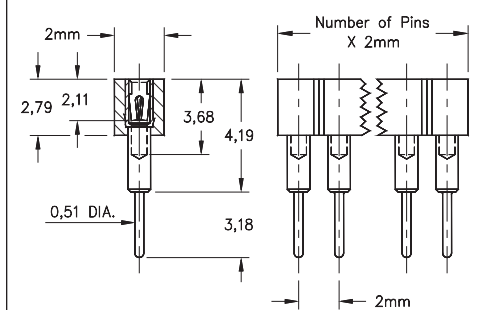


FIG. 3

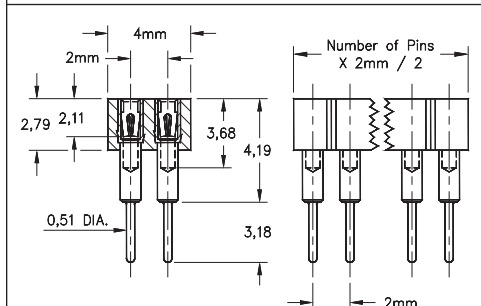


FIG. 4

- Series 830 single & double row interconnects have 2mm pin spacing and permit board stacking as low as 8,18
- Pin headers (830 & 832 series) use MM #5012 pins. See page 208 for details
- Sockets (831 & 833 series) use MM #1802 receptacles and accept pin diameters from 0,38 - 0,64. See page 169 for details
- Contact is rated at 3 amps
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 830...001	Single Row Pin Header		
	830-XX-0-10-001000 Specify number of pins 01-50			
FIG. 2	Series 832...001	Double Row Pin Header		
	832-XX--10-001000 Specify number of pins 002-100			
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264				
SPECIFY PLATING CODE XX=				
Pin Plating	10	90	40	
	0,25µm Au	5,08µm Sn/Pb	5,08µm Sn	

FIG. 3	Series 831...001		Single Row Socket		
	831-XX-0-10-001000 Specify number of pins 01-50				
FIG. 4	Series 833...001		Double Row Socket		
	833-XX--10-001000 Specify number of pins 002-100				
RoHS - 2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Enviromental Data, See page 264					
SPECIFY PLATING CODE XX=					
Sleeve (Pin)		91	93	41	43
		5,08µm Sn/Pb	5,08µm Sn/Pb	5,08µm Sn	5,08µm Sn
Contact (Clip)		0,25µm Au	0,76µm Au	0,25µm Au	0,76µm Au
					